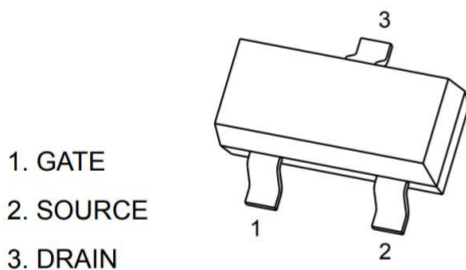


Product Summary

- V_{DS} 100 V
- I_{DS} ($V_{GS}=10V$) 2 A
- $R_{DS(ON)}$ ($V_{GS}=10V$) $\leq 250m\Omega$ (Typ)

Package and Pin Configuration

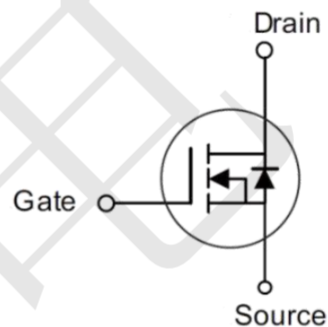


SOT23

Application

- Interfacing Switching
- DC-DC Converters
- Power management functions

Circuit diagram



Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current $T_A=25^\circ\text{C}$	I_D	2.0	A
Continuous Drain Current $T_A=70^\circ\text{C}$	I_D	1.6	A
Pulsed Drain Current ($t = 100 \mu\text{s}$)	I_{DM}	8.0	A
Maximum Power Dissipation	P_D	$T_A=25^\circ\text{C}$ 1.2	W
		$T_A=70^\circ\text{C}$ 0.8	W
Operating Junction Temperature Range	T_J	-55 to +150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55 to +150	$^\circ\text{C}$

Thermal Characteristic

PARAMETER	Symbol	Value	Unit
Thermal Resistance from Junction to Ambient($t \leq 10\text{s}$)	$R_{\theta JA}$	105	$^\circ\text{C/W}$

Note : When mounted on 1" square PCB (FR4 material).

Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static						
Drain-Source Breakdown Voltage	V _{GS} =0V, I _D = 10μA	BV _{DSS}	100	--	--	V
Gate-Source Threshold Voltage	V _{DS} =V _{GS} , I _D = 250μA	V _{GS(th)}	1.1	2.0	3.0	V
Gate-Source Leakage	V _{DS} =0V, V _{GS} = ±20V	I _{GSS}	--	--	±100	nA
Zero Gate Voltage Drain Current	V _{DS} = 100V, V _{GS} =0V	I _{DSS}	--	--	1.0	μA
Drain-Source On-State Resistance (Note 1)	V _{GS} = 10V, I _D = 2.0A	R _{DS(on)}	--	250	280	mΩ
	V _{GS} = 4.5V, I _D = 2.0A		--	260	310	
Forward Transconductance (Note 2)	V _{DS} = 5V, I _D = 1.0A	g _{fs}	--	36	--	S
Dynamic (Note 2)						
Input Capacitance	V _{DS} = 50V, V _{GS} = 0V, F= 1.0MHz	C _{iss}	--	330	--	pF
Output Capacitance		C _{oss}	--	88	--	
Reverse Transfer Capacitance		C _{rss}	--	17	--	
Switching						
Turn-On Delay Time (Note 3)	V _{DS} = 50V, V _{GS} = 10V, I _D = 1.3A, R _G = 1Ω.	t _{d(on)}	--	14	--	nS
Rise Time (Note 3)		t _r	--	54	--	
Turn-Off Delay Time (Note 3)		t _{d(off)}	--	18	--	
Fall Time (Note 3)		t _f	--	11	--	
Total Gate Charge	V _{DS} = 50V, I _D = 2A, V _{GS} = 10V	Q _g	--	5.3	--	nC
Gate Source Charge		Q _{gs}	--	1.4	--	
Gate Drain Charge		Q _{gd}	--	1.8	--	
Source-Drain Diode Ratings and Characteristics (Note 2)						
Forward Voltage	V _{GS} = 0V, I _F = 1A	V _{SD}	--	0.8	1.2	V
Continuous Source Current	Integral reverse diode in the MOSFET	I _s	--	--	2.0	A
Pulsed Current (Note 1)		I _{SM}	--	--	8.0	A

Notes:

1. Pulse test; pulse width ≤ 300 μS, duty cycle ≤ 2%.
2. Guaranteed by design, not subject to production testing.
3. Independent of operating temperature

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

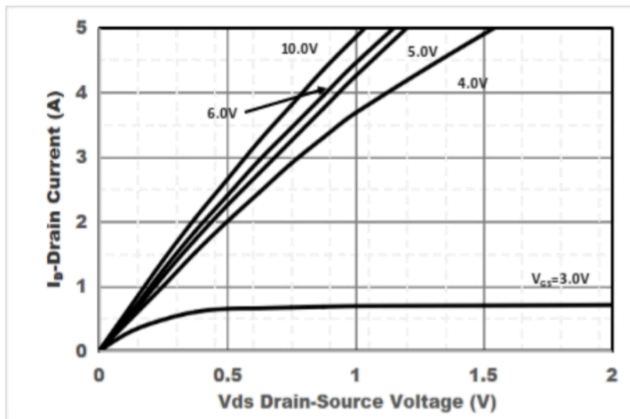


Figure1. Output Characteristics

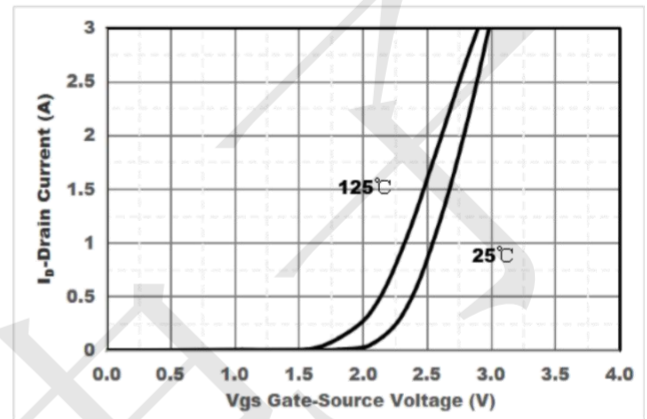


Figure2. Transfer Characteristics

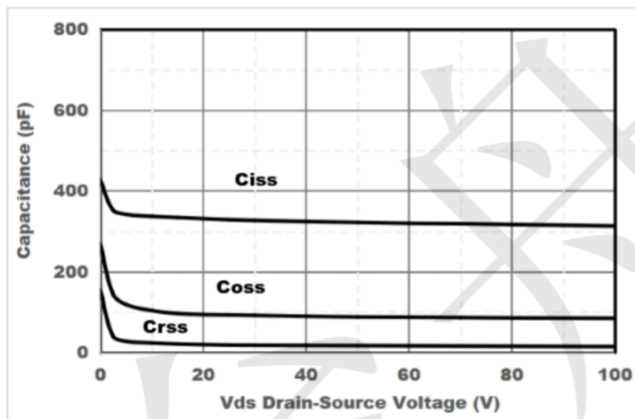


Figure3. Capacitance Characteristics

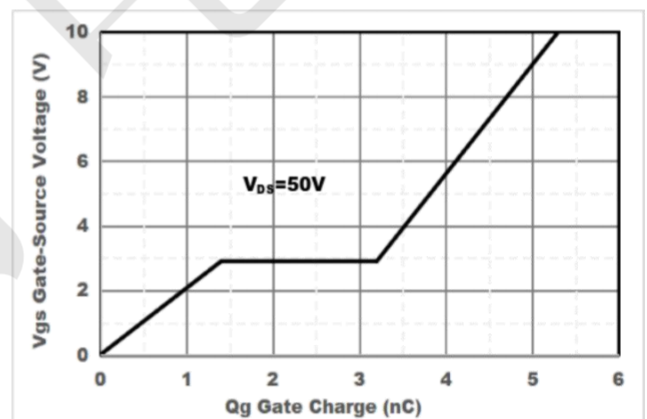


Figure4. Gate Charge

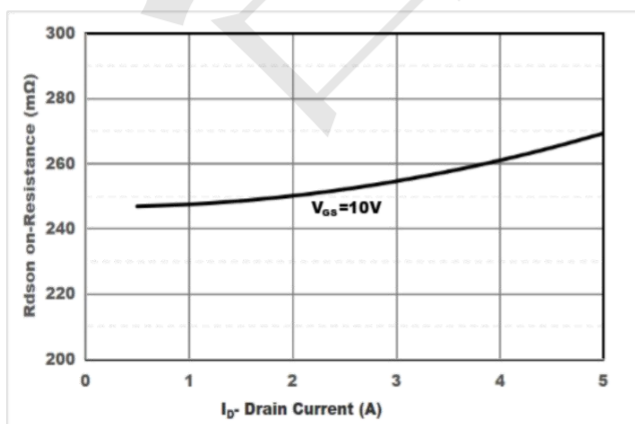


Figure5. Drain-Source on Resistance

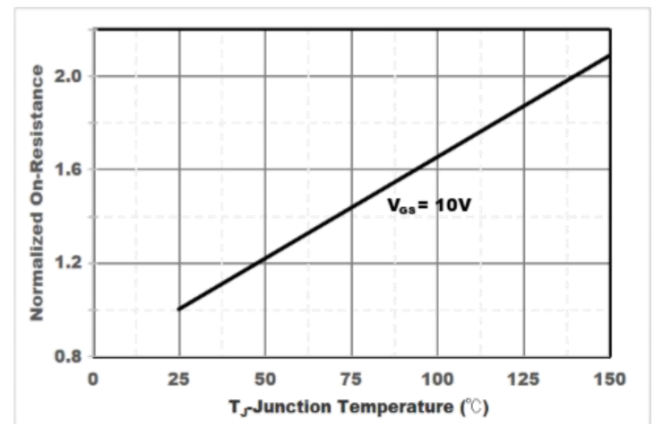
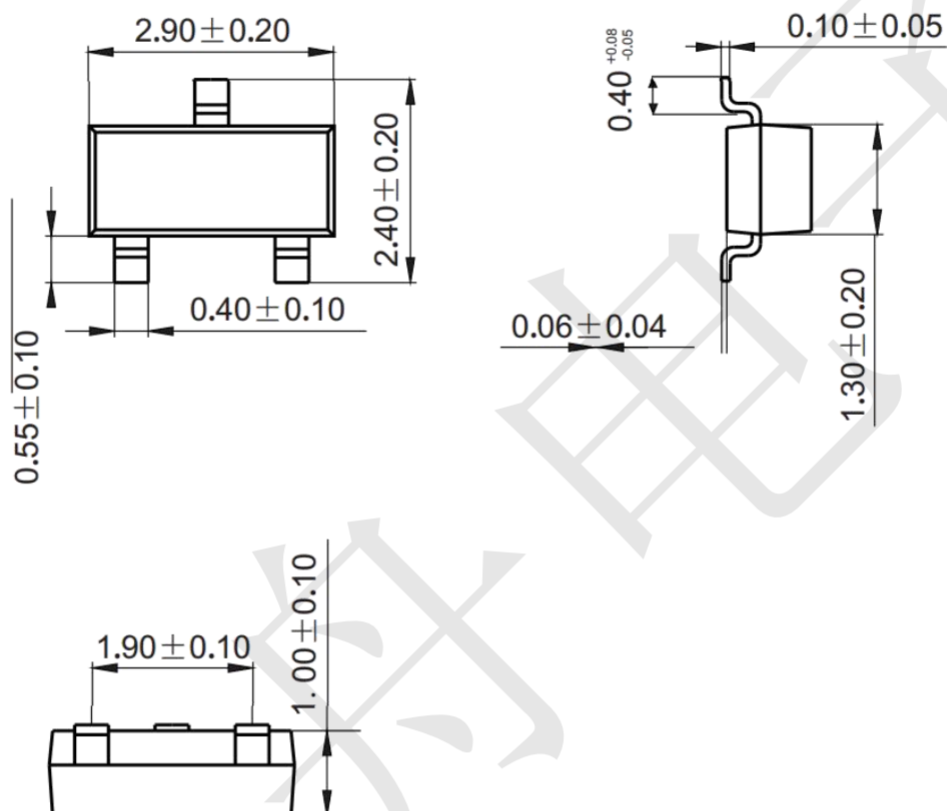


Figure6. Drain-Source on Resistance

Package Outline Dimensions (unit: mm)

SOT23



Mounting Pad Layout (unit: mm)

